

Application Note

Safety startup application note

Introduction

Safety plays an increasingly important role in the field of electronic applications. In electronic design, the level of component safety requirements is rising, and electronic equipment manufacturers are incorporating many new technology solutions into new component designs. Software technologies for improving safety are emerging. Standards of hardware and software safety requirements are also under continuous development.

This document describes how the project in N32G401 MCU perform the requirements of IEC60730 software safety related operations and related application code content.

This document applies to the N32G401 series products of NSING Technologies.





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1. IEC60730 Class B Software Standard Introduction

To ensure the safety of electrical appliances, risk control measures during software operation need to be evaluated.

IEC60730, issued by the International Electrotechnical Commission, introduces the requirements for the evaluation of software for household appliances. In Appendix H (H.2.21), software is classified as follows:

Class A software: the software only implements the functions of the product and does not involve the safety control of the product. For example, software for household thermostats, lighting controls...

Class B software: software designed to prevent unsafe operation of electronic devices. For example, the software of washing machine with automatic door lock control, the software of induction cooker software with overheating control...

Class C software: software designed to avoid certain specific danger. Such as automatic burner control and thermal cut-off for enclosed water heater (mainly for device that may cause explosions)

The specific evaluation requirements of class B software include components to be tested and related faults and test schemes, which are sorted out in the following table (refer to IEC60730 Table H.11.12.7):

Table 1-1 IEC60730 Class B Evaluation Requirement

Components To F	Ge Detected	Fault/Error	Fault Classification	Nsing With Library	Test Solution Overview
1.CPU	1.1 register	Hysteresis (Stuck at)	MCU related	Y	Write relevant registers and check
1.CFU	1.3 Program counter	Hysteresis (Stuck at)	MCU related	Y	When the PC crashes, the watchdog reset is triggered
2.Interruption		No interrupts or interrupts too frequently	Application related	N	Count the number of interrupts
3. The clock		Wrong frequency	MCU related	Y	Use HSI to measure HSE clock frequency
	4.1 Non-volatile memory	All single bit errors	MCU related	Y	FLASH CRC integrity check of Flash
4. Memory	4.2 Volatile memory	DC fault	MCU related	Y	SRAM March C test Stack overflow detection
	4.3 Addressing (related to non- volatile and volatile memory)	Hysteresis (Stuck at)	MCU related	Y	Flash /SRAM tests are included
5. Internal data path	5.1 data	Hysteresis (Stuck at)	MCU related	N	Only for MCUs using external memory,



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	5.2 addressing	Wrong address	MCU related	N	monolithic MCUs are not required
	6.1 data	The Hamming distance is 3	Application related	N	Add verification in data
External communication	6.2 addressing	Wrong address	Application related	N	transfer
	6.3 sequential	Wrong timing	Application related	N	Count the number of communication events
7. Input and	7.1 digital I/O	Error defined in H27	Application related	N	None
output	7.2 Analog input and output	Error defined in H27	Application related	N	None

2. Test Point Process Description

The check content of class B software package program is divided into two main parts: self-check at startup and periodic self-check at runtime. Self-test at startup includes:

- CPU self-check
- Watchdog self-check
- Flash integrity self-check
- RAM function self-check
- System clock self-check
- Control flow self-check

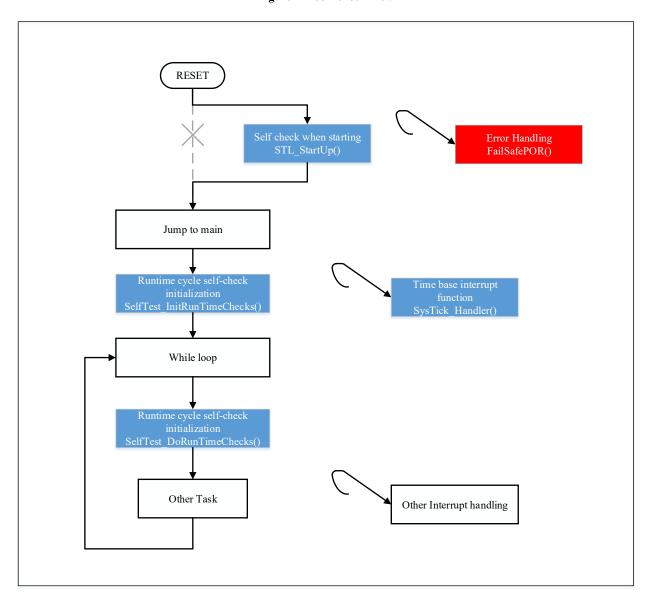
Periodic self-check at runtime:

- Partial CPU core register self-check
- Stack boundary overflow self-check
- System clock running self-check
- Flash CRC segmentation self-check
- Watchdog self-check
- Partial RAM self-check (in interrupt service routines)

The overall flow diagram is as follows:



Figure 2-1 Self-check Flow



2.1 Check Flow at Startup

Before the chip enters **main** function from startup, the startup self-check is carried out first. The startup file is modified to execute this part of the code. After the self-check process is over, the **__iar_program_start** function is called to jump back to **main** function.

The following is a flow diagram for performing a startup self-check:



RESET fail CPU registers and flags self test HW reset WDOGs functionality self test fail Non-volatile memory CRC check STL StartUp() fail Volatile memory functional test fail Clock Frequency Self Test fail Verify Control flow Main routine FailSafePOR()

Figure 2-2 Self-check Flow at Startup

2.1.1 CPU Self-Check At Startup

CPU self-check mainly checks whether the core flags, registers and so on are correct. If an error occurs, FailSafePOR () is called.

CPU self-check will be carried out at both startup and runtime. At startup, a self-check will be conducted on the functionality of registers R0~R12, PSP, MSP register and Z(zero), N(negative), C(carry), V(overflow) flag bit. During runtime, there will be periodic self-check, which is only applied to registers R1~R12.

Register self-check is implemented as follows: write 0xAAAAAAA and 0x55555555 to the register respectively, and then compare whether the read value is the written value; write 1 after R1 is tested, write 2 after R2 is tested, and so on.



Flag bit self-check is implement as follows: set the flag bits respectively; if an error is detected in the flag bits, enter the fault function. The diagram of self-check flow is as follows:

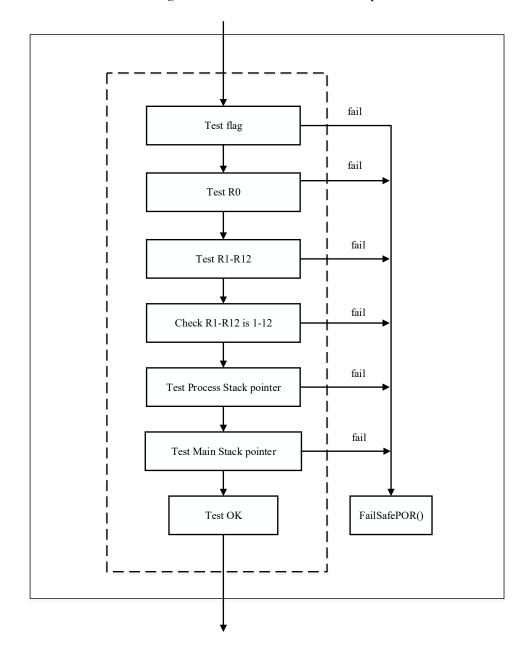


Figure 2-3 CPU Self-check Flow at Startup

2.1.2 Watchdog Self-Check at Startup

Watchdog self-check is to test the independent watchdog and window watchdog to confirm that they can be reset correctly to ensure that if the program crashes during runtime, the system can reset in time to prevent a deadlock.

The self-check process is: after the initial reset, clear all reset status register flag bits; start the IWDG test, reset the chip, and judge whether the IWDG reset flag bit is set; if it is set, start the WWDG test to reset the chip; if the WWDG reset flag bit is set, the watchdog test passes; clear all flags.



The flow diagram is as follows:

RESET YES Do not reset the watchdog Clear all flags SW reset HW reset Clear all flags IWDG Reset? Start IWDG test; YES HW reset NO WWDG Reset Start WWDG test; YES Clear all flags Test OK

Figure 2-4 Watchdog Self-check Flow at Startup

2.1.3 FLASH Self-check at Startup

FLASH self-check is a program that calculates Flash data with CRC algorithm. Then compares the result value with the CRC value stored in the specified location of Flash, which is calculated during compilation, to confirm the integrity of Flash.

The flow diagram is as follows:



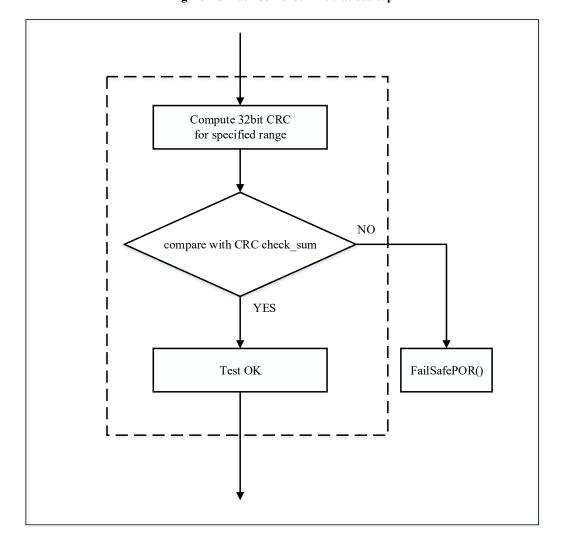


Figure 2-5 Flash Self-check Flow at Startup

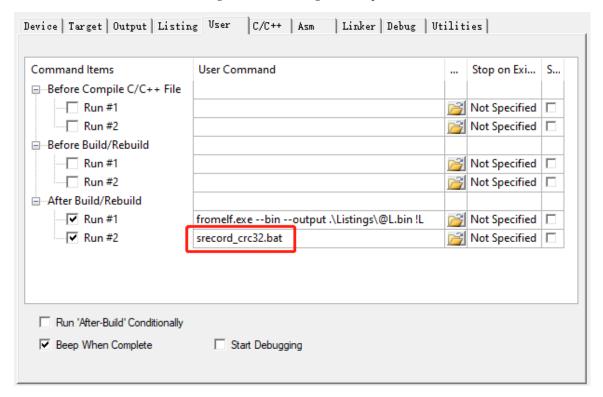
The address range of Flash range for CRC calculation is configured according to the actual situation of the whole program.

The configuration of Keil is complicated. ARM officially recommends using the third-party software SRecord for ROM Self-Test in MDK-ARM.

According to the project configuration, after the compilation is completed, the script file srecord_crc32.bat will be called. Then by running the srec_cat.exe software, the data in the N32G401_SelfTest.hex file generated by Keil compilation will be subjected to CRC calculation, The generated CRC check result will be added to a specified location to obtain the new N32G401_SelfTest_CRC.hex file:



Figure 2-6 Keil Configuration Option



Open the .bat file with Notepad or other tools, and modify the following according to the actual application:

Figure 2-7 Keil .bat File Configuration

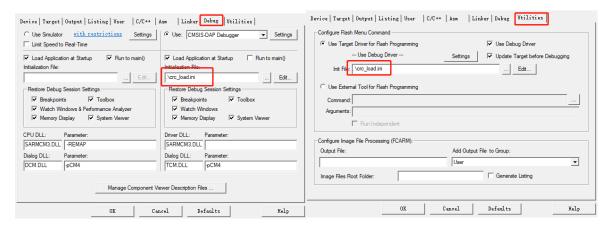
Range of calculating CRC in the program can be configured in to the n32g401_STLparam.h file, according to the requirements, which is consistent with the above configuration in above figure:

Figure 2-8 Keil .h File Configuration

Therefore, whether it is downloading or debugging, the final generated N32G401_SelfTest_CRC.hex file needs to be used. So, the .ini file needs to be added to the Keil configuration option to download the new .hex file. The configuration is as follows:

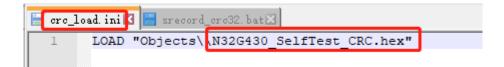


Figure 2-9 Keil Configuration to Add .ini File



It should be noted that the .ini file should also be configured with the file name of the actual application requirements that need to be modified.\

Figure 2-10 Keil .ini File Configuration



2.1.4 RAM Self-check at Startup

SRAM self-check detects errors not only in the data region, but also in its internal address and data path.

SRAM self-check uses The March-C algorithm, which is used for SRAM testing of embedded chips as part of safety certification. All ranges of SRAM are checked at startup.

First, the whole SRAM is cleared. Then, set the SRAM data to 1 bit by bit, and check if this bit is set successfully. If this bit is set, continue to next bit till whole SRAM range is done. Otherwise, an error is reported. After all bits in SRAM are set, clear it to 0 bit by bit and check if this bit is cleared. If this bit is cleared, continue to next bit till entire SRAM range is done. Otherwise, an error is reported.

The test is divided into 6 loops, where the values 0x00 and 0xFF are alternately filled and checked word by word in the entire RAM. The first 3 loops are executed with increasing addresses, while the last 3 loops are executed with decreasing addresses.

The entire RAM self-check algorithm process is shown in the figure below:



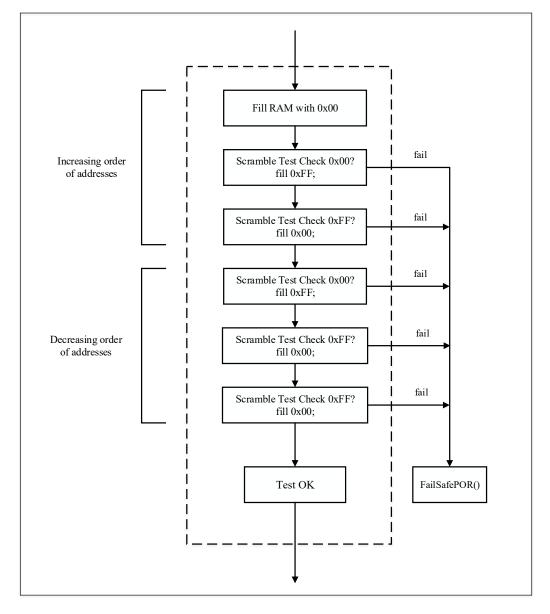


Figure 2-11 RAM Self-check Flow at Startup

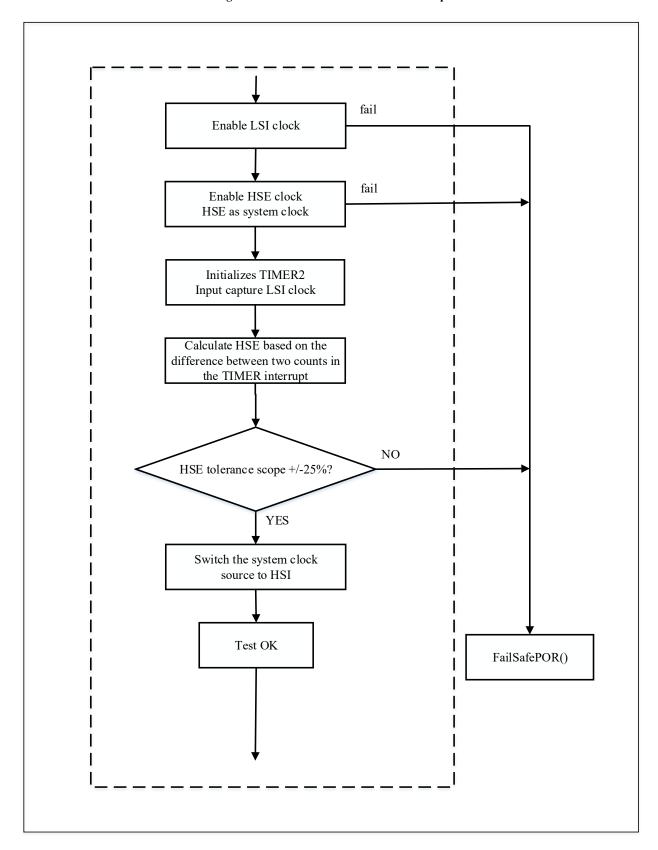
2.1.5 Clock Self-check at Startup

The self-check process is as follows:

- 1. Start the low-speed internal (LSI) clock source.
- 2. To measure HSE, use the macro definition to select HSE, start the high-speed external (HSE) clock source, and configures it as the system clock. Otherwise, use the macro definition to select HSI, and configures the system clock to select PLL (the source is HSI).
- 3. Initialize TIMER2, input the captured LSI clock; judge in the interrupt, the value obtained by the timer counter two consecutive times is different, so that the ratio between the LSI and HSE frequencies can be obtained.
- 4. Calculate the HSE frequency and compare the frequency value to the expected range value: if it exceeds the expected range by +/- 25%, the test fails. Switch the system clock source HSI after the test. The expected range value can be adjusted by the user according to the actual application. The macros are defined as HSE LimitHigh() and HSE LimitLow().



Figure 2-12 Clock Self-check Flow at Startup



2.1.6 Control Flow Self-check at Startup

The self-check part of the startup ends with the control flow self-check pointer program.



Initialize the variables CtrlFlowCnt to 0, and CtrlFlowCntInv to 0xFFFFFFFF. After each test step, CtrlFlowCnt adds a fixed value, and CtrlFlowCntInv subtracting the same fixed value. At the end of the startup self-check, judge whether the sum of the two values is still 0xFFFFFFFF.

2.2 Self-check Process at Runtime

If the startup self-check passes successfully, the run-time periodic self-check must be initialized before entering the main loop.

The runtime self-check is performed periodically based on SysTick.

The run-time periodic self-check process is as follows:

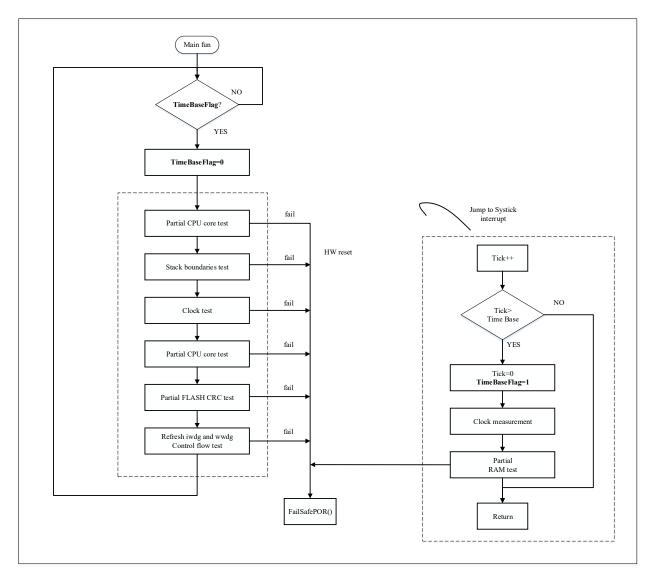


Figure 2-13 Self-check Flow at Runtime

2.2.1 CPU Runtime Self-check

The CPU runtime periodic self-check is similar to the self-check at startup, except that the core flags and stack pointers are not checked.



Push R4-R7

Test R1-R12

Fail Fail

Test OK

FailSafePOR()

Figure 2-14 CPU Self-check Flow at Runtime

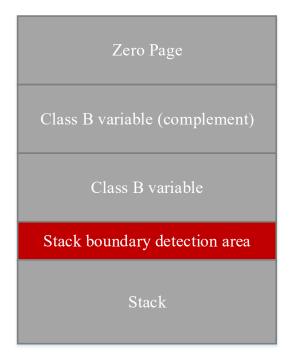
2.2.2 Stack Boundary Runtime Overflow Self-check

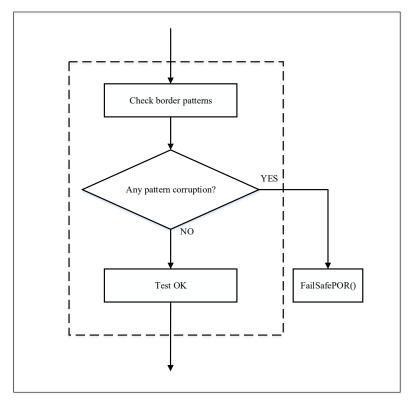
This test detects stack overflow by determining the data integrity of pattern array in the boundary detection area. If the original pattern data is corrupted, the test fails and a fault-tolerant program is invoked.

The lower address closely following the stack area is defined as the stack boundary detection area. This area can be configured differently depending on the device. The user must define enough areas for the stack and ensure that pattern is placed correctly.



Figure 2-15 Stack Boundary Self-Check Flow at Runtime





2.2.3 System Clock Runtime Self-check

The self-check of the system clock at runtime is similar to the detection of the clock at startup. The HSE frequency is calculated from the difference between the two captures. The process is as follows:



Calculate the difference between two captures NO HSE tolerance scope +/-25%? YES Test OK FailSafePOR()

Figure 2-16 System Clock Self-Check Flow at Runtime

2.2.4 FLASH Runtime self-check

The Flash CRC self-check is performed during the runtime. The self-check time length varies depending on the check range . The check range forsegmented CRC calculation can be configured based on the size of the user application. When the CRC values are calculated to the last range, the CRC values are compared. If the values are not expected, the self-check fails.



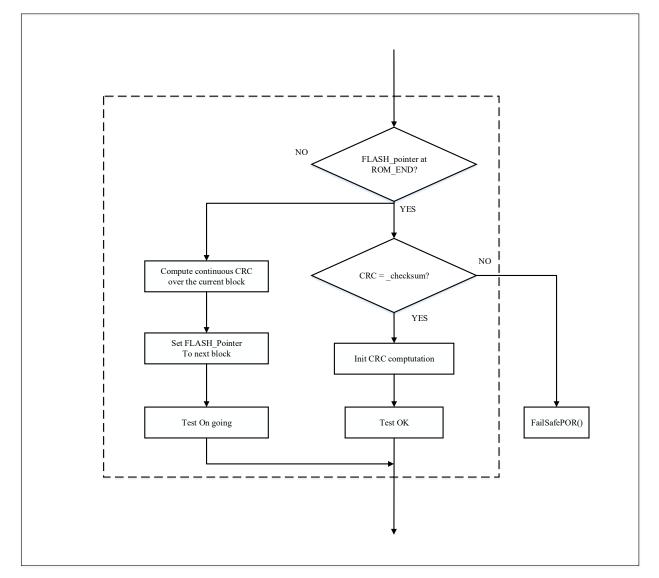


Figure 2-17 Flash Self-check Flow at Runtime

2.2.5 Watchdog Runtime Self-check

During runtime, watchdogs need to be fed regularly to ensure the normal operation of the system. The watchdog feeding part is placed at the end of STL DoRunTimeChecks().

2.2.6 Partial RAM Runtime Self-check

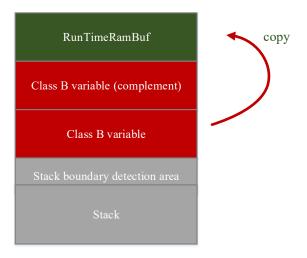
The RAM self-check at run time is done in the SysTick interrupt function. The test covers only the partial memory allocated to the class B variable.

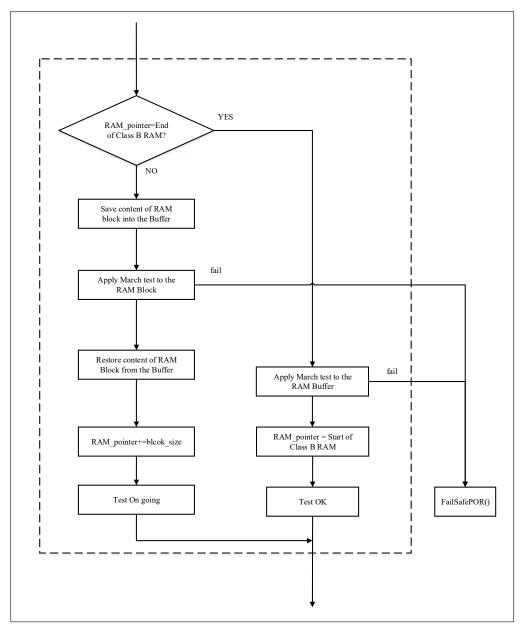
The area allocated to the class B variable, is divided into blocks, which each block consisting of 6 bytes. Before the March-C test, save the block data in the RunTimeRamBuf, and then put the data in RunTimeRamBuf back to the original position of the class B area after the test is completed. Repeat the operation until all tests in the class B area are completed.

After the class B area test is complete, the March-C test is performed in RunTimeRamBuf zrea. After the test is complete, the pointer is restored to the class B start address for the next test.



Figure 2-18 RAM Self-check Flow at Runtime





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3. Key Points of Software Library Migration

- Before executing the user program, execute the STL_StartUp function (to start the self-check);
- Set WWDG and IWDG to prevent them from being reset when the program is running normally;
- Set up RAM and Flash detection range at startup and runtime;
 - The range of CRC checksum, and the location where the checksum is stored in the Flash
 - The range of storage addresses for Class B variables
 - Location of stack boundary self-check area
- Troubleshoot detected faults.
- Add user-related fault detection content based on specific applications;
- Define the frequency of program runtime self-check according to the specific application;
- After the chip is reset, the STL_StartUp function must be called for startup self-check before
 initialization.
- Call STL_InitRunTimeChecks() before entering the main loop, and call STL_DoRunTimeChecks() in the main loop;
- Users can release Verbose comments to enter diagnostic mode and output text information through the Tx pin(PA9) of USART1.

Set the serial port to 115200Bits/s, no parity, 8-bit data, and 1 stop bit.



4. Version History

Version	Date	Changes
V1.0.0	2023.06.14	Initial release



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